

Features

- 5050 with integrated high quality constant current IC and RGB LED chip.
- Built-in IC, with high precision of constant current and internal RGB chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGB output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

Description

The IN-PI55TAT(X)R(X)G(X)B is 5.0*5.0*1.6mm RGB LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen

Package Outline Dimensions & Pin Configuration

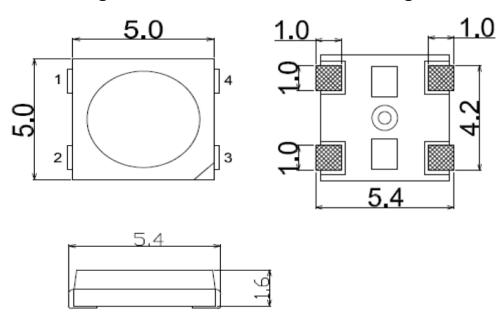


Figure 1. IN-PI55TAT(X)R(X)G(X)B Package Outline Dimensions



Pin Configuration

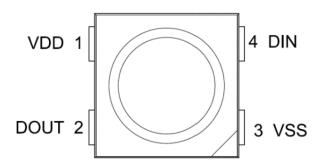


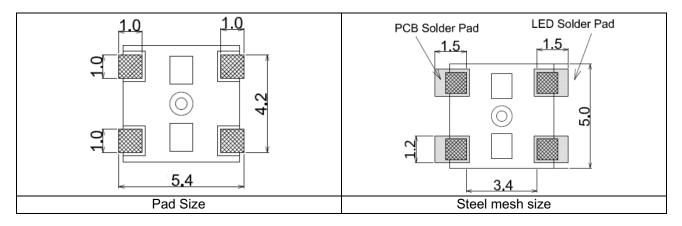
Figure 2. IN-PI55TAT(X)R(X)G(X)B Pin Configuration

Notes:

1. Dimension in millimeter, tolerance is ± 0.1 mm unless otherwise noted.

Number	Symbol	Function Description		
1 VDD Power supply LED				
2	DOUT	Control data signal output		
3	VSS	Ground		
4	DIN	Control data signal input		

Soldering Pad Size



Notes:

1. Dimension in millimeter, tolerance is $\pm 0.1 \text{mm}$ unless otherwise noted.



Absolute Maximum Rating (Ta = 25 °C, VSS=0V)

Parameter	Symbol	Range	Unit
Logic supply voltage	V _{DD}	+3.5~+5.5	V
Logic input voltage	VIN	-0.5 ~VDD+0.5	V
Operating temperature	Торт	−45 ~ +85	°C
Storage temperature	Тѕтв	−50 ~ +150	°C
ESD pressure(HBM)	Vesd	4K	V
ESD pressure(DM)	Vesd	200	V

LED Characteristics (*Ta* = 25°C)

Color	5n	nA	12mA				
Color	Wavelength(nm)	Light Intensity(mcd)	Wavelength(nm)	Light Intensity(mcd)			
Red	620-630	200-400	620-630	700-1000			
Green	520-535	520-535 1000-1500		1500-2200			
Blue	460-475	50-100	460-475	700-1000			



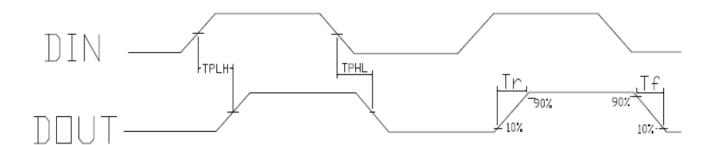
$\textbf{Recommended Operating Ranges} \ \textit{(unless otherwise specified, Ta= -20 \sim +70 \ \textit{C, VDD=4.5} \sim 5.5 \textit{V,VSS=0V)} \\$

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
Supply voltage	V_{DD}	1	5.2	1	>	-
R/G/B port pressure	Vds, max	-	-	26	V	-
DOUT drive capability	IDон	1	49	1	mA	maximum source current
DOUT drive capability	IDoL	1	-50	1	mA	maximum sink current
High level input voltage	V _{IH}	3.4	ı		V	VDD=5.0V
Low level input voltage	V _{IL}	-	-	1.6	V	VDD=5.0V
The frequency of PWM	F _{РWМ}	-	1.2	-	KHZ	-
Static power consumption	I _{DD}	-	1	-	mA	-



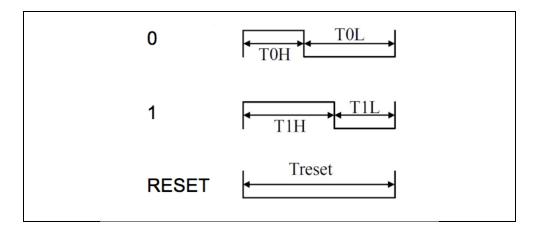
Switching Characteristics (unless otherwise specified, Ta=25 °C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
The speed of data transmission	fDIN	ı	800	ı	KHZ	The duty ratio of 67% (data 1)
DOLIT transmission dalou	T_{PLH}	-	-	500	ns	DIN DOUT
DOUT transmission delay	T_{PHL}	-	-	500	ns	DIN→DOUT
L Diag/Duan Time	Tr	-	100	-	ns	VDS=1.5
I _{OUT} Rise/Drop Time	T_f	-	100	-	ns	I _{оит} =5/13mA



Timing Waveforms

1. Input Code

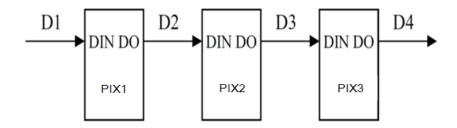




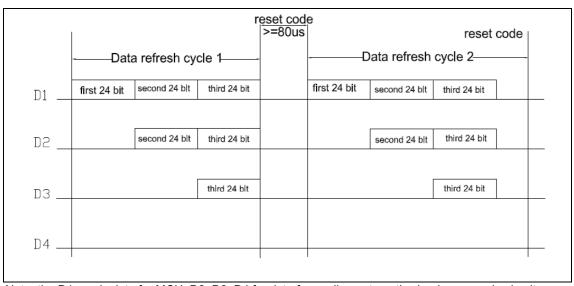
2. The data transmission time (TH+TL=1.25µs±600ns):

Name	Description	Typ. value	error
T0H	0 code, high level time	0.3µs	±0.15μs
T0L	0 code, low level time	0.9µs	±0.15μs
T1H	1 code, high level time	0.9µs	±0.15μs
T1L	1 code, low level time	0.3µs	±0.15μs
Trst	Reset code, low level time	80µs	

3. Connection Scheme



4. Data Transfer Format



Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

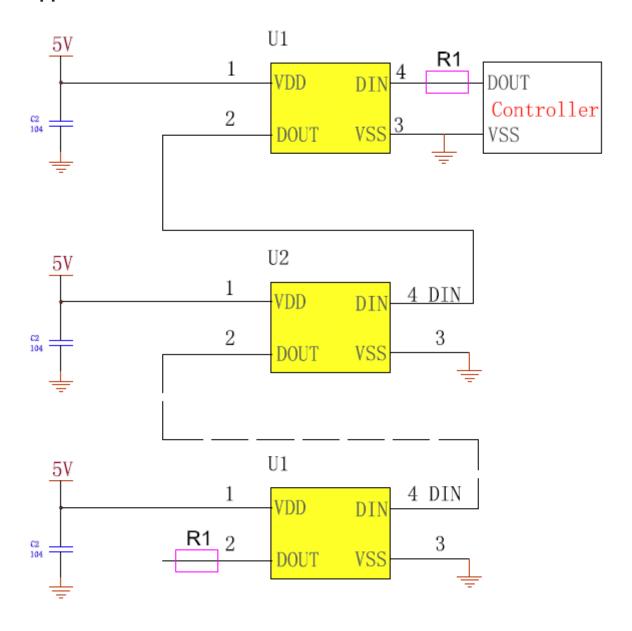
5. 24-bit data format

G7	G6	G5	G4	G3	G2	G1	G0	R7 R6		R5	R4
R3	R2	R1	RO	В7	В6	B5	В4	В3	B2	В1	ВО

Note: high starting, in order to send data (G7 - G6 -B0)



Typical Application Circuit

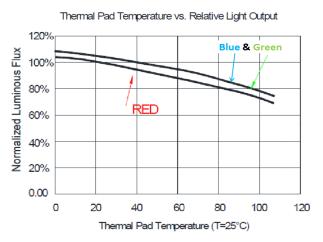


Product signal input and output must be connected in series with protection resistor R1. R1 depends on the size of the cascade amount, the greater the number of cascade, the smaller R1. The general recommended value is between $200-2K\Omega$, usually the recommended value is typical 500Ω .

Wavelength Characteristics



LED Performance Graph



100% BLUE GREEN RED

60%

60%

0.00

400

450

500

550

600

650

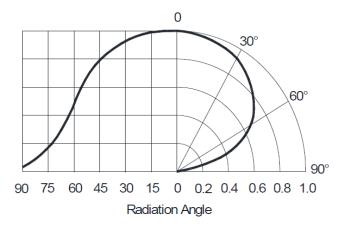
700

750

800

Wavelength (nm)

Typical Radiation Pattern 120°





Ordering Information

Product	Emission Color	IV(mcd)	Orderable Part Number			
	R	200-400				
IN-PI55TAT5R5G5B	G	1000-1500	IN-PI55TAT5R5G5B			
	В	50-100	1			
	R	700-1000				
IN-PI55TATPRPGPB	G	1500-2200	IN-PI55TATPRPGPB			
	В	700-1000				

Label Specifications



Inolux P/N:

I	N	PI	-	55	Т	Α	Т	(X)	R	(X)	G	(X)	В	-	Х	Х	Χ	Χ
		Product		Package	Die Qty.	Variation	Orientation	Current	Color	Current	Color	Current	Color			Custor Stam		
Inol	ux	PI- Single trace IC PC- Clock Function IC		55TA = 5	.0 x 5.0 x pins)	1.6 mm (4	T = Top Mount	P=12mA 5 = 5mA	R = 624 nm	P=12mA 5 = 5mA	G = 520 nm	P=12mA 5 = 5mA	B = 470 nm					

Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2010 \		Month	Dato	Corial
Tracker		fear (2017)	, 2018,)	WOULI	Date	Serial	



IN-PI55TAT(X)R(X)G(X)B 5050 RGB LED 4-Pin with Integrated IC

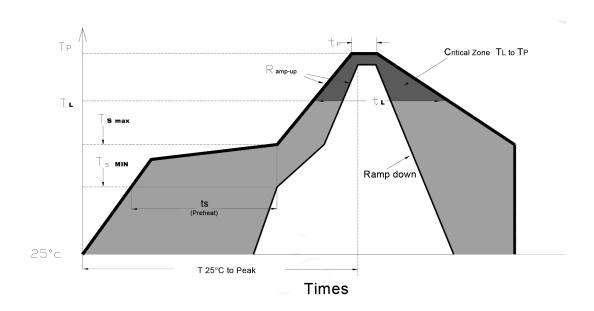
Precautions

Please read the following notes before using the product:

- Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the LEDs should be kept at 30% or less and 60%RH or less.
- 1.5 The LEDs should be used within 24 hours (1 days) after opening the package.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.



2. Soldering Condition
Recommended soldering conditions:



Profile Feature	Lead-Free Solder				
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.				
Preheat: Temperature Min (Ts _{min})	150℃				
Preheat: Temperature Min (Ts _{max})	200℃				
Preheat: Time (ts _{min to} ts _{max})	60-180 seconds				
Time Maintained Above: Temperature (T _L)	217 ℃				
Time Maintained Above: Time (t L)	60-150 seconds				
Peak/Classification Temperature (T P)	240 ℃				
Time Within 5℃ of Actual Peak Temperature (tp)	<10 seconds				
Ramp-Down Rate	6℃/second max.				
Time 25 ℃ to Peak Temperature	<6 minutes max.				

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.



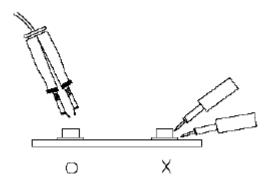
IN-PI55TAT(X)R(X)G(X)B 5050 RGB LED 4-Pin with Integrated IC

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



IN-PI55TAT(X)R(X)G(X)B 5050 RGB LED 4-Pin with Integrated IC

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-31-2018
Format Adjustment		1.1	07-01-2018

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